

Declaration for Patent Application

Supplemental (37 C.F.R. §1.67)

~~I, the above-named inventor, I hereby declare that:~~

My residence, mailing address and citizenship are as stated next to my name;

I believe I am the original, first and sole inventor (if only one name is listed) or an original, first and joint inventor (if plural names are listed in the signatory page(s) commencing at page 2 hereof) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SOLDER COMPOSITION

the specification of which (check one)

- is attached hereto.
- was filed on March 17, 2004 as United States Application Number 10/802,387.
- was filed on [PCT Filing Date] as PCT International Application No. [PCT Appl'n No.] [and assigned United States Application No. []].
- and was amended on [] (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. 119 or 365 of any foreign application(s) for patent or inventor's certificate, or of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>	Priority Not Claimed	Certified Copy Filed? YES	Certified Copy Filed? NO
(Number)	(Country)	(Day/Month/Year filed)	[] [] []
(Number)	(Country)	(Day/Month/Year filed)	[] [] []
(Number)	(Country)	(Day/Month/Year filed)	[] [] []

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole

or first inventor Premakaran T. Boaz

Inventor's Signature _____ Date _____

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Full name of second joint

inventor, if any John Pereira

Inventor's Signature J. P. J. Date 4/20/04

Residence 223 Agricultural Avenue, Rehoboth, Massachusetts, 02769

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Full name of third joint

inventor, if any _____

Inventor's Signature _____ Date _____

Residence _____

Citizenship _____

Mailing Address _____

Full name of fourth joint

inventor, if any _____

Inventor's Signature _____ Date _____

Residence _____

Citizenship _____

Mailing Address _____